# **MA4Z159** (MA4S159)

## Silicon epitaxial planar type

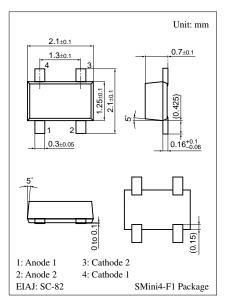
#### For switching circuits

#### ■ Features

- Small S-mini type 4-pin package
- Two isolated elements contained in one package, allowing highdensity mounting
- Flat lead type, resulting in improved mounting efficiency and solderability with the high-speed mounting machine
- Short reverse recovery time t<sub>rr</sub>
- Small terminal capacitance, C<sub>t</sub>

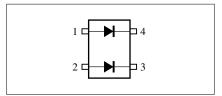
### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage (DC)		$V_R$	80	V
Peak reverse voltage		$V_{RM}$	80	V
Average forward	Single	I <sub>F(AV)</sub>	100	mA
current	Double		75	
Peak forward	Single	$I_{FM}$	225	mA
current	Double		170	
Non-repetitive peak	Single	$I_{FSM}$	500	mA
forward surge current*	Double		375	
Junction temperature		T <sub>j</sub>	150	°C
Storage temperature		$T_{stg}$	-55 to +150	°C



Marking Symbol: M1B

#### Internal Connection



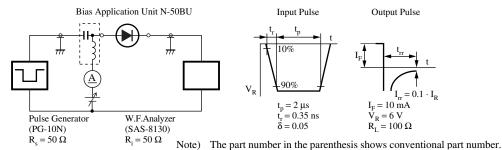
Note) \*: t = 1 s

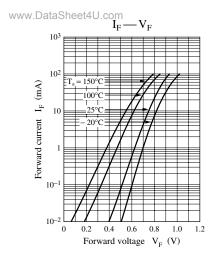
### ■ Electrical Characteristics $T_a = 25$ °C

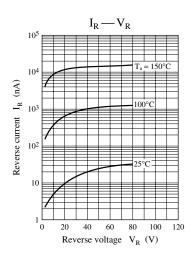
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	$I_R$	$V_R = 75 \text{ V}$			0.1	μΑ
Forward voltage (DC)	V <sub>F</sub>	$I_F = 100 \text{ mA}$		0.95	1.2	V
Reverse voltage (DC)	V <sub>R</sub>	$I_R = 100 \mu A$	80			V
Terminal capacitance	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$		0.9	2	pF
Reverse recovery time*	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			3	ns
		$I_{rr} = 0.1 \cdot I_{R}, R_{L} = 100 \Omega$				

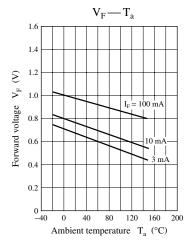
Note) 1. Rated input/output frequency: 100 MHz

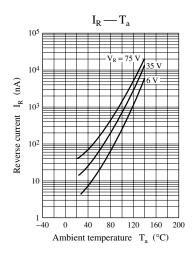
#### 2. \*: t<sub>rr</sub> measuring circuit

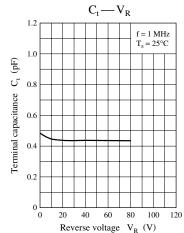


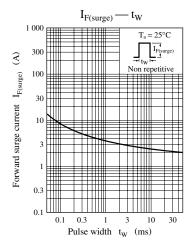












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